

# **PRODUCT / PROCESS CHANGE NOTIFICATION**

PCN-000644

**Date: March 15, 2021** P1/3

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	Chan	re Deteile				
Dowt Newsbords Afford		ge Details	Affordada Navia			
Part Number(s) Affect	ea:	ustomer Part Number(s)	Affected: 🗵 N/A			
• GS3490-INE3						
<ul> <li>GS3490-INTE3</li> </ul>						
• GS3490-INTE3D						
• GS3490-INTE3V						
• GS3490-INTE3Z						
G35490-INTE32						
Description, Purpose	and Effect of Change					
Description, rui pose	and Enect of Onlinge	1				
GS3490 is currently assen	nhled at ASEM Semtech	is qualifying alternative sour	re in Taiwan Greatek for			
•		GS3490 is currently assembled at ASEM. Semtech is qualifying alternative source in Taiwan, Greatek, for				
5x5mm 32L QFN package assembly. The purpose is capacity expansion.						
	assembly. The purpose is	capacity expansion.				
	, , ,					
Change Classification	⊠ Major ☐ Minor	Impact to Form, Fit, Function	☐ Yes ⊠ No			
Change Classification Impact to Data Sheet	, , ,	Impact to Form, Fit,	☐ Yes   ⊠ No			
Impact to Data Sheet	<ul><li>✓ Major</li></ul>	Impact to Form, Fit, Function New Revision or Date				
	<ul><li>✓ Major</li></ul>	Impact to Form, Fit, Function New Revision or Date				
Impact to Data Sheet Impact to Performance		Impact to Form, Fit, Function New Revision or Date Reliability:				
Impact to Data Sheet Impact to Performance No impact to product pe		Impact to Form, Fit, Function New Revision or Date				
Impact to Data Sheet Impact to Performance		Impact to Form, Fit, Function New Revision or Date Reliability:				
Impact to Data Sheet Impact to Performance No impact to product periodentical, no impact to for		Impact to Form, Fit, Function New Revision or Date Reliability:	■ N/A  utline dimensions remain			
Impact to Data Sheet Impact to Performance No impact to product periodentical, no impact to for Implementation Date	Major ☐ Minor ☐ Yes ☒ No e, Characteristics or I rformance, characteristi m fit and function.  June 15, 2021	Impact to Form, Fit, Function New Revision or Date Reliability: cs and reliability. Package of Work Week				
Impact to Data Sheet Impact to Performance No impact to product peridentical, no impact to for Implementation Date Last Time Ship (LTS)		Impact to Form, Fit, Function New Revision or Date Reliability:  cs and reliability. Package of Work Week Affecting Lot No. /	■ N/A  utline dimensions remain			
Impact to Data Sheet Impact to Performance No impact to product periodentical, no impact to for Implementation Date	Major ☐ Minor ☐ Yes ☒ No e, Characteristics or I rformance, characteristi m fit and function.  June 15, 2021	Impact to Form, Fit, Function New Revision or Date Reliability: cs and reliability. Package of Work Week	N/A  N/A			



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**Supporting Documents for Change Validation/Attachments:** 

• PRODDOC004353 Reliability Report rev 1

#### Bill of Material of GS3490



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OSAT	ASEM	<u>Greatek</u>	
Leadframe	DCI - MEP	Shinko - MEP	
Epoxy (Die 1)	CRM1076	Hitachi 4900 GC	
DAF (Die 2)	Hitachi HR5104	Hitachi HR5104	
Mold compound	G770HCD	G700H	
Wire	1mil CuPd wire		

### **Process Flow & Machine list**



Process	AS	ЕМ	Greatek		
	Machine maker	Machine model	Machine maker	Machine model	
Backgrind	Disco	PG300RMA	Disco	DFG 850, 8540, 8560	
Wafer saw	Disco	D641	Disco	DFD-6340, 6361, 6560	
Die Attach	ASM	ASM 898	BESI	2100 series	
Wire Bond	KNS	Maxum series	KNS & ESEC	Iconn, ProCu, 3100, 3200	
Molding	Daiichi	GP-PRO8	TOWA Y1		
Reflow	BTU International	Furnace_6	Tangteck	SMD-18-M10HA0	
Package saw	Disco	D6340	TOWA	FMS 3040	



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Issuing Authority					
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# **GS3490**Reliability Qualification Report

## **Revision History**

Version	ECO	Date	Modifications / Changes
0	ECO-017993	Feb. 2014	New document
1	ECO-055930	Mar. 2021	Adding Greatek as a second source for packaging qualification details (PCN-000644). Plus minor formatting updates.

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#### 1 Device Specifics

#### 1.1 Manufacturing Summary

 Table 1.
 Manufacturing Summary

Manufacturing Summary	1		
Semtech Device Codes	GS3490		
Silicon Fab Technology	Jazz Semi SiGe 0.18 μm SBC18H2A		
Assembly House	ASE-M Greatek		
Package Type	32QFN, 5x5 mm, 0.5 mm pitch		
Leadframe	DCI-MEP (ASE-M) Shinko- MEP (Greatek)		
Epoxy (Die 1)	CRM1076 (ASE-M) Hitachi 4900 GC (Greate		
DAF (Die 2)	Hitachi HR5104 (ASE-M) Hitachi HR5104 (Greatek)		
Mold Compound	G770HCD (ASE-M)	G700H (Greatek)	
Wire	1 mil CuPd wire		

#### 1.2 Product Information

The GS3490 is a high-speed integrated circuit featuring adaptive cable equalization and cable driver functionality. The GS3490 is optimized for applications with limited I/O space. With its configurable EQ and Cable driver functionality, the GS3490 can be utilized as a single-device solution in applications where the interface connector can be configured as either an input or output. The GS3490's cable equalizer is optimized for operation at 2.97Gb/s, 1.485Gb/s and 270Mb/s while providing typical cable reach of 140m at 2.97Gb/s, 260m at 1.485Gb/s and 500m at 270Mb/s.

The GS3490 is Pb-free, and the encapsulation compound does not contain halogenated flame retardant. This component and all homogeneous subcomponents are RoHS compliant.

#### 1.3 Process Qualification

The GS3490 is manufactured in Jazz Semiconductor 0.18um SiGe SBC18H2A process. The Jazz qualification report is accepted on Agile# GENDOC-048070.

#### 1.4 Product Qualification Approach

The GS3490 contains two co-packaged previously qualified silicon die, EQ – GS3440 and CblDrv – GS2988. The GS3440 is a subset of the GS3441 and the GS2988 is a subset of the GS2989. As both individually qualified die are placed in a stacked configuration, and each die operates independently, there is very low risk of thermal runaway from combined self heating. HTOL data from GS3441 and GS2989 is considered representative of the GS3490. Therefore GS3490 HTOL is bridged to the GS3441 and GS2989.

The GS3490 is utilizing a DAF (die-attach-film) between the two vertically stacked die with standard die attach epoxy between the lower GS3440 die and the die paddle. Due to its new packaging design full package qualification, ESD and LU were executed. LTS was added specifically for the DAF qualification.

Greatek is being qualified as a second source for packaging assembly of the stacked die 32L QFN. As the BOM is changing, a full packaging qualification is underway. LTS was not repeated as the DAF is the same as used at ASE-M.

Specific details can be found in table 2 on the next page.

## 2 Reliability Qualification Stresses

## 2.1 Environmental Tests

Table 2.Environmental Tests

Stress	Conditions	Duration	Qualification Vehicle	Sample Size	Result
High Temperature Operating Life	JESD22-A108	1000 hrs	GS3441	80	Pass
	$T_j \ge 125^{\circ}C$ , $V_{cc} \ge V_{ccmax}$	1000 hrs	GS2989	80	Pass
	JESD22-A104	1000 cycles	GS3490 (ASE-M)	25 each from 3 lots	Pass
	MSL Preconditioning,				
Temperature	-55°C to +125°C (Condition B)				
Cycling	JESD22-A104	1000 cycles	GS3490 (Greatek)	79 from 1 lot	Pass
	MSL Preconditioning,			25 each from 2 lots	In Progress
	-65°C to +125°C (Condition C)				
High Temperature	JEDSE22-A103	1000 hours	GS3490 (ASE-M)	25 each from 3 lots	Pass
	150 °C		GS3490 (Greatek)	80 pcs 1 lot	Pass
Storage				25 each from 2 lots	In Progress
Unbiased HAST	JESD22-A118	96 hours	GS3490 (ASE-M)	25 each from 3 lots	Pass
TIAOT	MSL Preconditioning,		GS3490 (Greatek)	79 pcs 1 lot	Pass
	130°C/85% RH		,	25 each from 2 lots	In Progress
Maiatura	J-STD-020		GS3490 (ASE-M)	50 each from 3 lots	Pass
Moisture Sensitivity	MSL3, Tmax=260 °C		GS3490 (Greatek	238 from 1 lot	Pass
Level				50 each from 2 lots	In Progress
Low	JESD22-A119	168hrs	GS3490 (ASE-M)	25 each from 3 lots	Pass
Temperature Storage	-55 °C				

## 2.2 Electrostatic Discharge and Latch Up Tests

 Table 3.
 Electrostatic Discharge and Latch Up Tests

Stress	Conditions	Qualification Vehicle	Stress Level	Sample Size	Results
Human Body Model ESD	JESD22-A114	GS3490	1, 2, 2.5KV, 3 kV	3	Pass
Machine Model ESD	JESD22-A115	GS3490	100, 150, 200 V	3	Pass
Charged Device Model ESD	JESD22-C101	GS3490	1, 1.5, 2 kV	3	Pass
	JESD78	GS3490	25°C	3	
Latch Up	V <sub>cc</sub> =3.5 V, 5.25 V; +/- 100 mA Level II, Class A	•	85°C	3	Pass

#### 3 Conclusion

The GS3490 product passed all reliability testing and is fully qualified in the ASE-M 32L stacked die QFN package.

Greatek has been added as a second source for GS3490 packaging assembly. 1 lot has completed qualification and no performance degradation was observed during the evaluation so far. This report will be updated upon completion of Greatek qualification.